

1<sup>st</sup> Executive Forum on Laser Technologies **SAVE THE DATE**

**FROM NEW TECHNOLOGIES  
TO EMERGING APPLICATIONS**

SHENZHEN, CHINA **SEPT. 6 PM  
& SEPT. 7 2017** Alongside China International  
Optoelectronic Expo

Organized by  
**YOLE**  
Développement

Hosted by  
**CIOE**  
CHINA INTERNATIONAL  
OPTOELECTRONIC  
EXPO

## CALL FOR PAPER

Yole Développement and CIOE welcome original submissions in the following range of areas:

### Emerging applications:

- LIDAR
- 3D Imaging
- Biomedical applications (printing bio-parts, smart implants...)

### Future applications:

- Matrix laser lighting
- Healthcare 3D printing
- Holography

### New technologies:

- Gesture recognition
- Sensor fusion
- Packaging
- Ultra-fast laser
- Optics

**Please submit abstract (200 words max.)** to Camille Veyrier ([veyrier@yole.fr](mailto:veyrier@yole.fr)) by **April 26, 2017**. Your abstract can include one or two illustrations (graph, images...).

### About the 1st Executive Forum on Laser Technologies: From New Technologies to Emerging Applications

Yole Développement is proud to collaborate with CIOE to organize the 1st Executive Forum on Laser Technologies. The forum will bring together a worldclass panel of manufacturers, integrators and users experts and allow participants to get valuable insights into the status and future of the laser industry as well as provide unprecedented opportunities for meeting with industry leaders.

Over 1.5 day, it will address laser emerging applications and key markets, new technologies, and future trends. This 1st forum is must for all laser industry executives as well as for manufacturers, integrators and users managers to network and learn about all the latest industry trends. It will take place on September 6 and 7, 2017 in Shenzhen, alongside the 19th China International Optoelectronic Expo 2017.

**More information on [i-Micronews.com](http://i-Micronews.com) or contact Camille Veyrier ([veyrier@yole.fr](mailto:veyrier@yole.fr)).**

**Go on page 2 for the guidelines for submission**

## GUIDELINES FOR PAPER SUBMISSION

Papers must be original material and not have been previously presented or published.

- **Content:** technology and/or market focused content with in-depth information and analysis. The quality of the description of your presentation matters. The ability of your description to clearly explain what the attendees will take away from your presentation is critical for your submission to make it through the review process. The abstract must clearly describe the nature, scope, content, organization, key points and significance of the proposed paper.
- **Speaker:** please include short biography to the submitted paper.
- **Language:** all papers will be in English. Nevertheless, the conference presentation language can be Chinese as we organize a translation service.
- **Procedure:** only papers submitted within the call for paper period will be accepted.
- **Exclusivity:** the paper may not be used for another conference in parallel, prior to the forum. It will be then sent to the attendees only.
- **Commercial aspect:** no commercial papers will be accepted. The presentation will not include direct or hidden product ads. In the presentation, only one slide is dedicated to company introduction. Product brand names may be mentioned infrequently if necessary for explanations.
- **Speaker benefits:** 1 free entrance per company to the forum, announcement with abstract, bio and photo on forum webpage and program, presentation sent to all attendees, announcement in the forum promotion.

### IMPORTANT DATES

Please make sure the following deadlines and dates are respected:

- **Call for Paper opens: April 4, 2017**
- **Abstract due: April 26, 2017**
- **Author notification sent: May 10, 2017**
- **Speaker letter agreement due: May 30, 2017**
- **PowerPoint presentation due: August 18, 2017**

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